Multilayer Ceramic Chip Capacitors CGB2A3JB1A474M033BB

RoHS Reach Halogen Free Pb Free

TDK item description CGB2A3JB1A474MT****

Applications	Commercial Grade	
Feature	LowT Low Profile	
Series	CGB2(1005) [EIA 0402]	
	Production (Not Recommended for New Design)	
Status	Recommended Alternate Part No. : CGB2A3X5R1A474K033BB (Interchangeability	
	is not guaranteed.)	



	Size
Length(L)	1.00mm ±0.05mm
Width(W)	0.50mm ±0.05mm
Thickness(T)	0.30mm ±0.03mm
Terminal Width(B)	0.10mm Min.
Terminal Spacing(G)	0.30mm Min.
Recommended Land Pattern (PA)	0.30mm to 0.50mm
Recommended Land Pattern (PB)	0.35mm to 0.45mm
Recommended Land Pattern (PC)	0.40mm to 0.60mm

Electrical Characteristics		
Capacitance	470nF ±20%	
Rated Voltage	10VDC	
Temperature Characteristic	JB(±10%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	212ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	NO
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	10000pcs

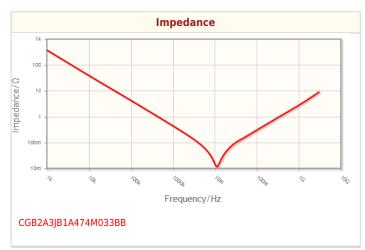
 $^{!\ \}mbox{Images}$ are for reference only and show exemplary products.

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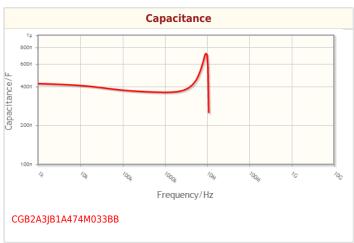
 $^{! \ \}mbox{All specifications}$ are subject to change without notice.

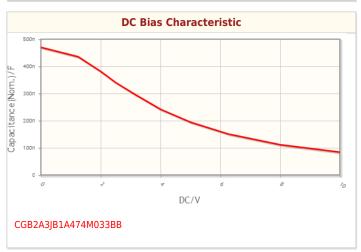
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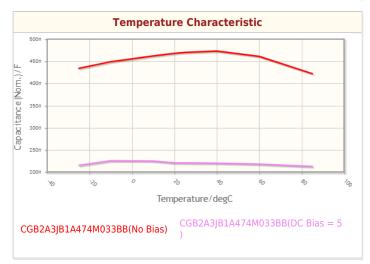
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

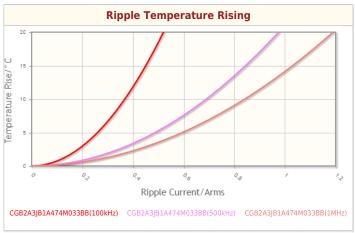












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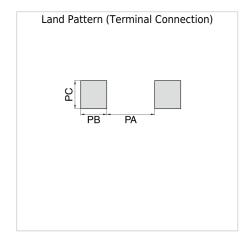
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Associated Images



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